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NC7SZ125 TinyLogic[®] UHS Buffer with Three-State Output

Features

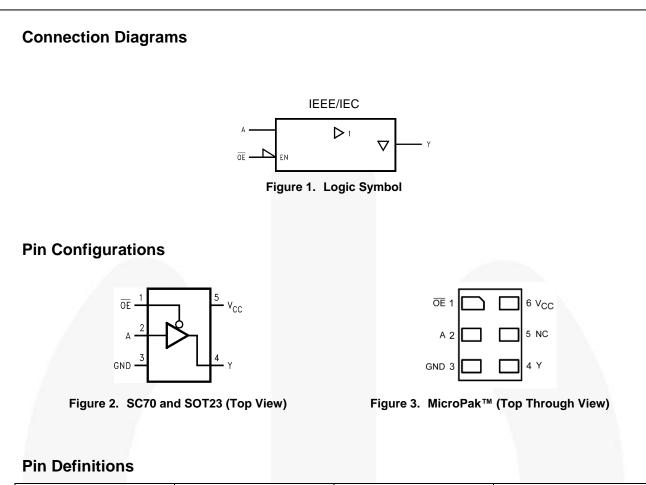
- Ultra-High Speed: t_{PD} 2.6 ns (Typical) into 50 pF at 5 V V_{CC}
- High Output Drive: ±24 mA at 3 V V_{CC}
- Broad V_{cc} Operating Range: 1.65 V to 5.5 V
- Matches Performance of LCX Operated at 3.3 V V_{CC}
- Power Down High-Impedance Inputs/Outputs
- Over-Voltage Tolerance Inputs Facilitate 5 V to 3 V Translation
- Proprietary Noise/EMI Reduction Circuitry
- Ultra-Small MicroPak[™] Packages
- Space-Saving SOT23 and SC70 Packages

Description

The NC7SZ125 is a single buffer with three-state output from Fairchild's Ultra-High Speed (UHS) of TinyLogic[®]. The device is fabricated with advanced CMOS technology to achieve ultra high speed with high output drive while maintaining low static power dissipation over a very broad V_{CC} operating range. The device is specified to operate over the 1.65 V to 5.5 V range. The inputs and output are high impedance above ground when V_{CC} is 0 V. Inputs tolerate voltages up to 6 V independent of V_{CC} operating voltage. The output tolerates voltages above V_{CC} when in the 3-STATE condition.

Part Number	Top Mark	Package	Packing Method
NC7SZ125M5X	7Z25	5-Lead SOT23, JEDEC MO-178 1.6 mm	3000 Units on Tape & Reel
NC7SZ125P5X	Z25	5-Lead SC70, EIAJ SC-88a, 1.25 mm Wide	3000 Units on Tape & Reel
NC7SZ125L6X	DD	6-Lead MicroPak™, 1.00 mm Wide	5000 Units on Tape & Reel
NC7SZ125FHX	DD	6-Lead, MicroPak2, 1x1 mm Body, .35mm Pitch	5000 Units on Tape & Reel

Ordering Information



Pin # SC70 / SOT23	Pin # MicroPak	Name	Description
1	1	OE	Input
2	2	A	Input
3	3	GND	Ground
4	4	Y	Output
5	6	V _{CC}	Supply Voltage
	5	NC	No Connect

Function Table

In	puts	Output
/OE	In A	Out Y
L	L	L
L	н	н
Н	Х	Z

H = HIGH Logic Level

L = LOW Logic Level

X = HIGH or LOW Logic Level

Z = HIGH Impedance State

NC7SZ125 — TinyLogic[®] UHS Buffer with Three-State Output

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Paramet	er	Min.	Max.	Unit
V _{cc}	Supply Voltage		-0.5	6.0	V
V _{IN}	DC Input Voltage		-0.5	6.0	V
V _{OUT}	DC Output Voltage		-0.5	6.0	V
	DC Input Diada Current	V _{IN} < -0.5 V		-50	mA
I _{IK}	DC Input Diode Current	V _{IN} > 6.0 V		+20	mA
	DC Output Diede Current	V _{OUT} < -0.5 V		-50	~ ^
I _{OK}	DC Output Diode Current	$V_{OUT} > 6 V, V_{CC}=GND$		+20	mA
I _{OUT}	DC Output Current			±50	mA
I _{CC} or I _{GND}	DC V _{CC} or Ground Current			±50	mA
T _{STG}	Storage Temperature Range		-65	+150	°C
TJ	Junction Temperature Under Bias			+150	°C
TL	Junction Lead Temperature (Solderi	ng, 10 Seconds)		+260	°C
		SOT-23		200	
Р	Bower Dissipation at 185°C	SC70-5		150	mW
P _D	Power Dissipation at +85°C	MicroPak-6		130	TTIVV
		MicroPak2-6		120	
ESD	Human Body Model, JESD22-A114			4000	v
E3D	Charged Device Model, JESD22-C1	01		2000	

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Conditions	Min.	Max.	Unit	
N	Supply Voltage Operating		1.65	5.50	V	
V _{cc}	Supply Voltage Data Retention	ta Retention		5.50	v	
V _{IN}	Input Voltage		0	5.5	V	
V		Active State	0	V _{cc}	V	
V _{OUT}	Output Voltage	Three-State	0	5.5	V	
T _A	Operating Temperature		-40	+85	°C	
		V _{CC} at 1.8 V, 2.5 V ±0.2 V	0	20	< .	
t _r , t _f	Input Rise and Fall Times	V _{CC} at 3.3 V ±0.3 V	0	10	ns/V	
		V _{cc} at 5.0 V ±0.5 V	0	5		
		SOT-23		300		
0		SC70-5		425		
θ_{JA}	Thermal Resistance	MicroPak-6		500	°C/W	
		MicroPak2-6		560		

Note:

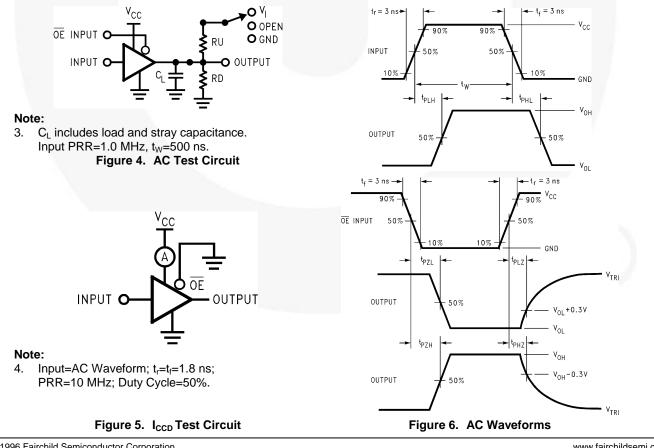
1. Unused inputs must be held HIGH or LOW. They may not float.

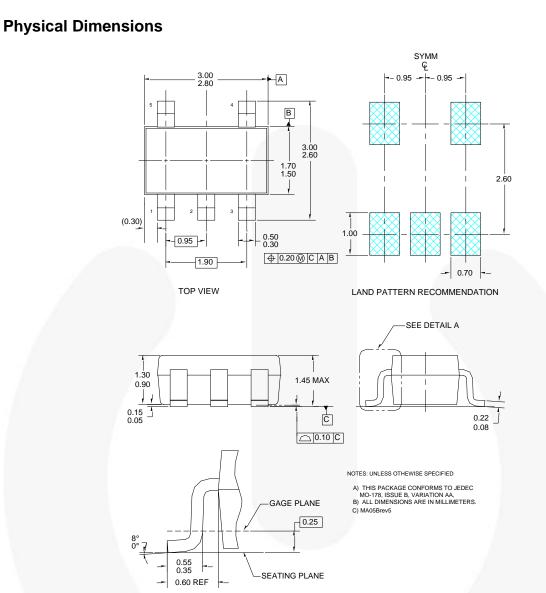
Dumple of	Demonster	N	O a maliti a ma	Conditions T _A =+25		°C $T_A=-40$ to		o +85°C	11
Symbol	Parameter	V _{cc}	Conditions	Min.	Тур.	Max.	Min.	Max.	Units
	HIGH Level	1.65 to 1.95		0.75V _{cc}			0.75V _{CC}		
V _{IH}	Input Voltage	2.30 to 5.50		0.70V _{cc}			$0.70V_{CC}$		V
	LOW Level Input	1.65 to 1.95				$0.25V_{CC}$		$0.25V_{CC}$	
V _{IL}	Voltage	2.30 to 5.50				$0.30V_{CC}$		$0.30V_{CC}$	V
		1.65		1.55	1.65		1.55		
		1.80		1.70	1.80		1.70		
		2.30	$V_{IN}=V_{IH}, I_{OH}=-100 \ \mu A$	2.20	2.30		2.20		V
		3.00		2.90	3.00		2.90		
N/	HIGH Level	4.50		4.40	4.50		4.40		
V _{OH}	Output Voltage	1.65	I _{OH} =-4 mA	1.29	1.52		1.29		
		2.30	I _{OH} =-8 mA	1.90	2.15		1.90		
		3.00	I _{OH} =-16 mA I _{OH} =-24 mA I _{OH} =-32 mA	2.40	2.80		2.40		
		3.00		2.30	2.68		2.30		
		4.50		3.80	4.20		3.80		
		1.65		0.00	0.10		0.00		
		1.80			0.00	0.10		0.10	
		2.30	$V_{IN}=V_{IL}$, $I_{OL}=100 \ \mu A$		0.00	0.10		0.10	
		3.00			0.00	0.10		0.10	
N/	LOW Level	4.50			0.00	0.10		0.10	
V _{OL}	Output Voltage	1.65	I _{OL} =4 mA		0.80	0.24		0.24	V
		2.30	I _{OL} =8 mA		0.10	0.30		0.30	
		3.00	I _{OL} =16 mA		0.15	0.40		0.40	
		3.00	I _{OL} =24 mA		0.22	0.55		0.55	
		4.50	I _{OL} =32 mA		0.22	0.55		0.55	
I _{IN}	Input Leakage Current	0 to 5.5	0 ≥ V _{IN} ≥ 5.5 V			±1		±10	μA
l _{oz}	3-STATE Output Leakage	0 to 5.5	$V_{IN}=V_{IH} \text{ or } V_{IL}$ $0 \ge V_O \ge 5.5 \text{ V}$			±1		±10	μA
I _{OFF}	Power Off Leakage Current	0	V_{IN} or V_{OUT} =5.5 V			1		10	μA
I _{cc}	Quiescent Supply Current	1.65 to 5.50	V _{IN} =5.5 V, GND			2		20	μA

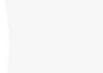
Cumb al	Deveneter	N/	Conditions	т	_=+25	°C	T _A =-40	to +85°C		F ierra
Symbol	Parameter	V _{cc}	Conditions	Min.	Тур.	Max.	Min.	Max.	Units	Figure
		1.65		2.0	6.4	13.2	2.0	13.8		
		1.80	C _L =15 pF,	2.0	5.3	11.0	2.0	11.5		
		2.50 ±0.20	$R_D=1 M\Omega$	0.8	3.4	7.5	0.8	8.0		
t _{PLH} , t _{PHL}	Propagation Delay	3.30 ±0.30	S1=OPEN	0.5	2.5	5.2	0.5	5.5	ns	Figure 4
YPLN, YPNL	r ropuguior Dolay	5.00 ±0.50		0.5	2.1	4.5	0.5	4.8	110	Figure 6
		3.30 ±0.30	C _L =50 pF,	1.5	3.2	5.7	1.5	6.0		
		5.00 ±0.50	R _D =500 Ω S ₁ =OPEN	0.8	2.6	5.0	0.8	5.3		
		1.65	C _L =50 pF,	2.0	8.4	15.0	2.0	15.6		
		1.80	R _D =500 Ω	2.0	7.0	12.5	2.0	13.0		
$t_{\text{PZL}}, t_{\text{PZH}}$	Output Enable Time	2.50 ±0.20	RU=500 Ω S ₁ =GND for t_{PZH} S ₁ =V _{IN} for t_{PZI}	1.5	4.6	8.5	1.5	9.0	_	
		3.30 ±0.30		1.5	3.5	6.2	1.5	6.5		
		5.00 ±0.50	V _{IN} =2•V _{CC}	0.8	2.8	5.5	0.8	5.8	ns	Figure 4
		1.65	C _L =50 pF,	2.0	6.5	13.2	2.0	14.5	115	Figure 6
		1.80	R _D =500 Ω	2.0	5.4	11.0	2.0	12.0		
$t_{\text{PLZ}}, t_{\text{PHZ}}$	Output Disable Time	2.50 ±0.20	RU=500 Ω S₁=GND for t _{PHZ}	1.5	3.5	8.0	1.5	8.5		
		3.30 ±0.30	$S_1 = GND \text{ for } t_{PHZ}$ $S_1 = V_{IN} \text{ for } t_{PLZ}$	1.0	2.8	5.7	1.0	6.0		
		5.00 ±0.50	V _{IN} =2•V _{CC}	0.5	2.1	4.7	0.5	5.0		
CIN	Input Capacitance	0.00			4				pF	
COUT	Output Capacitance	0.00			8					
0	Power Dissipation	3.30	17			_				
CPD	Capacitance ⁽²⁾	5.00			24				pF	Figure 5

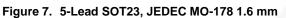
Note:

2. CPD is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output lading and operating at 50% duty cycle. C_{PD} is related to I_{CCD} dynamic operating current by the expression: $I_{CCD}=(C_{PD})(V_{CC})(f_{IN})+(I_{CC}static)$.









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Tape and Reel Specifications

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Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
M5X	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

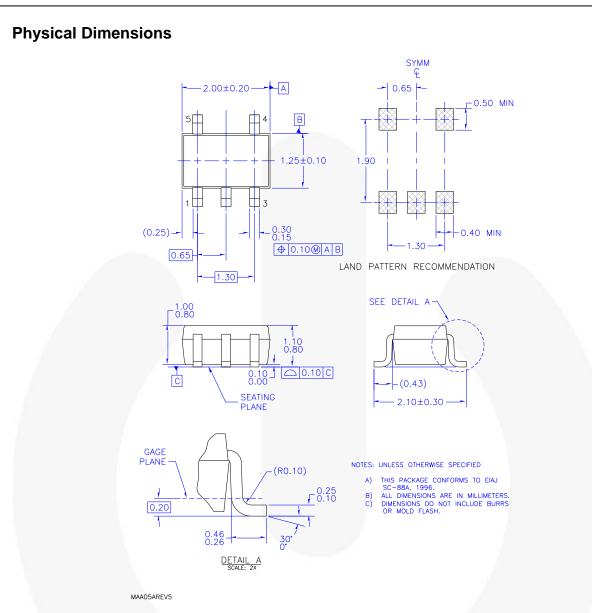


Figure 8. 5-Lead, SC70, EIAJ SC-88a, 1.25 mm Wide

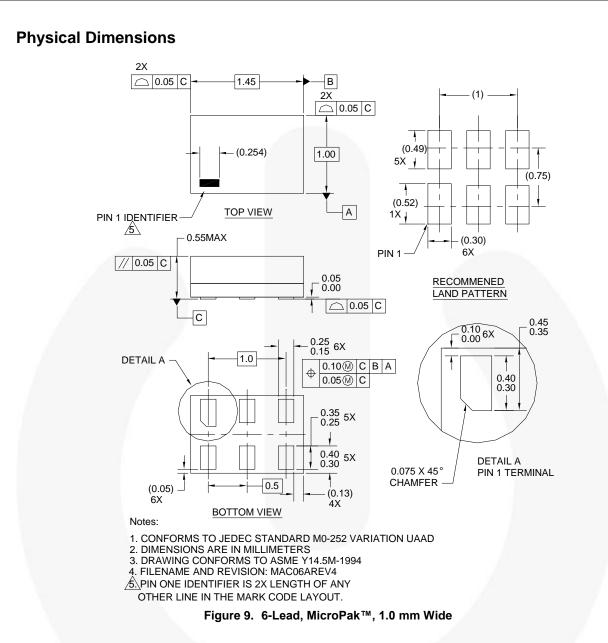
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Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
P5X	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed



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Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
L6X	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

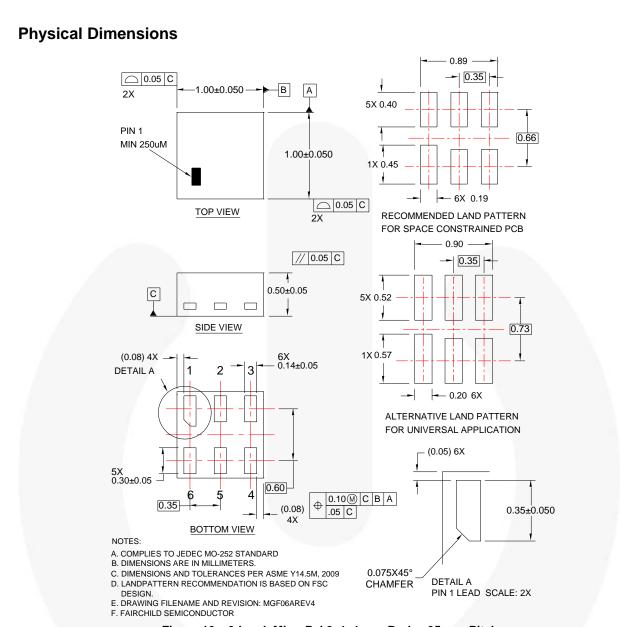


Figure 10. 6-Lead, MicroPak2, 1x1 mm Body, .35 mm Pitch

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Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
FHX	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

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